





#### EX8592-3LCD03

#### 10Gbps 850nm 300M XFP Optical Transceiver

- Supports 9.95Gbps to 11.1Gbps bit rates
- Maximum link length of 300m (50um,MMF,2000MHz.)
- 850nm VCSEL laser and PIN receiver
- XFP MSA Rev 4.5 Compliant
- No reference clock required
- +1.8V,+3.3V Supply Voltage
- Low Power Dissipation 1.5W Maximum
- > XFI and lineside loopback Mode Supported
- > 0°C to 70°C Operating Case Temperature
- Diagnostic Performance Monitoring of module temper Supply Voltages, laser bias current, transmit optical power, and receive optical power
- RoHS6 compliant (lead free)



### Applications

- > 10GBASE-SR/SW 10G Ethernet
- > 1200-Mx-SN-I 10G Fiber Channel
- SONET OC-192 SR-1 SDH STM I-64.1
- > Other optical links

## Description

ETU-Link EX8592-3LCD03 is compliant with the 10G Small Form-Factor Pluggable (XFP) Multi-Source Agreement (MSA), supporting data-rate of 10.3125Gbps (10GBASE-SR) or 9.953Gbps (10GBASE-SW), and transmission distance is up to 300m on 50µm MMF (2000MHz.km).

The transceiver module comprises a transmitter with 850nm a vertical cavity surface emitting (VCSEL) laser and a receiver with a PIN photodiode. Transmitter and receiver are separate within a wide temperature range of  $0^{\circ}$ C to +70 °C and offers optimum heat dissipation and excellent electromagnetic shielding thus enabling high port densities for 10G systems.

### **Absolute Maximum Ratings**

Parameter	Symbol	Min	Тур	Max	Unit
Maximum Supply Voltage	Vcc3	-0.5		4.0	V
Storage Temperature	Т <sub>s</sub>	-40		85	°C
Case Operating Temperature	T <sub>case</sub>	-5		70	°C

# Electrical Characteristics (T<sub>op</sub> = -5 to 70 °C, V<sub>cc3</sub> = 3.13 to 3.45 Volts)

Parameter	Symbol	Min	Тур	Мах	Unit	Ref.
Supply Voltage #2	Vcc3	3.13		3.45	V	
Supply Current – Vcc3 supply	Icc3			450	mA	
Module total power	Р			1.5	W	1
Transmitter						
Input differential impedance	Rin		100		Ω	2
Differential data input swing	Vin,pp	120		820	mV	
Transmit Disable Voltage	VD	2.0		Vcc	V	3
Transmit Enable Voltage	VEN	GND		GND+ 0.8	V	
Transmit Disable Assert Time				10	us	
Receiver						
Differential data output swing	Vout,pp	340	650	850	mV	4
Data output rise time	tr			38	ps	5
Data output fall time	tf			38	ps	5
LOS Fault	VLOS fault	Vcc - 0.5		VccHOST	V	6
LOS Normal	VLOS norm	GND		GND+0.5	V	6
Power Supply Rejection	PSR					7

#### Notes:

- 1) Maximum total power value is specified across the full temperature and voltage range.
- 2) After internal AC coupling.
- 3) Or open circuit.
- 4) Into 100 ohms differential termination.
- 5) These are unfiltered 20-80% values
- Loss of Signal is open collector to be pulled up with a 4.7k 10kohm resistor to 3.15 3.6V. Logic 0 indicates normal operation; logic 1 indicates no signal detected.
- 7) Per Section 2.7.1. in the XFP MSA Specification.

## Optical Characteristics (T<sub>op</sub> = -5 to 70 °C, V<sub>cc3</sub> = 3.13 to 3.45 Volts)

Parameter	Symbol	Min	Тур	Max	Unit	Ref.
Transmitter		•	•			
Average Optical Power	P <sub>AVE</sub>	-6		-1.0		1
Optical Wavelength	λ	840	850	860	nm	
Optical Extinction Ratio	ER	3.0	5		dB	
Transmitter and Dispersion Penalty	TDP			3.9	dB	
Average Launch power of transmitter	P <sub>OFF</sub>			-30	dBm	
Tx Jitter		Tx.	•		Per 802.3ae	
Tx Sitter		ľ Aj	requirements			
Encircled Flux	<4.5µm			30	%	2
Relative Intensity Noise	RIN <sub>12</sub> OMA			-128	dB/Hz	
Receiver						
Receiver Sensitivity@ 10.5Gb/s	R <sub>SENS</sub>			-10	dBm	
Input Saturation Power (Overload)	Psat	+0.5			dBm	
Wavelength Range	λ <sub>c</sub>	840		860	nm	
Receiver Reflectance	R <sub>rx</sub>			-12	dB	
LOS De-Assert	LOS			-12	dBm	
LOS Assert	LOS <sub>A</sub>	-30			dBm	
LOS Hysteresis		0.5			dB	

Notes:

- 1) Average power figures are informative only, per IEEE 802.3ae.
- 2) Measured into Type A1a (50/125 µm multimode) fiber per ANSI/TIA/EIA-455-203-2.

## **Pin Assignment**

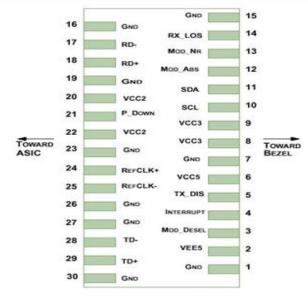


Diagram of Host Board Connector Block Pin Numbers and Name

Pin	in Logic Symbol		Name/Description		
1		GND	Module Ground	1	
2		VEE5	Optional –5.2 Power Supply – <b>Not required</b>		
3 LVTTL-I Mod-Desel			Module De-select; When held low allows the module to respond to 2-wire		
3	LVTTL-I Mod-Desel		serial interface commands		
			Interrupt (bar); Indicates presence of an important condition which can be		
4	LVTTL-O	Interrupt	read over the serial 2-wire interface	2	
5	LVTTL-I	TX_DIS	Transmitter Disable; Transmitter laser source turned off		
6		VCC5	+5 Power Supply – Not required		
7		GND	Module Ground	1	
8		VCC3	+3.3V Power Supply		
9		VCC3	+3.3V Power Supply		
10	LVTTL-I	SCL	Serial 2-wire interface clock		
11	LVTTL-I/O	SDA	Serial 2-wire interface data line	2	
12	LVTTL-O	Mod_Abs	Module Absent; Indicates module is not present. Grounded in the module.	2	
	3 LVTTL-O Mod_NR		Module Not Ready; ETU-LINK's defines it as a logical OR between	2	
13			Mod_NR RX_LOS and Loss of Lock in TX/RX.		
14	LVTTL-O	RX LOS	Receiver Loss of Signal indicator	2	
15		GND	Module Ground	1	
16		GND	Module Ground	1	
17	CML-O	RD-	Receiver inverted data output		
18	CML-O	RD+	Receiver non-inverted data output		
19		GND	Module Ground	1	
20		VCC2	+1.8V Power Supply – Not required		
			Power Down; When high, places the module in the low power stand-by		
		P Down/RS	mode and on the falling edge of P_Down initiates a module reset		
21	LVTTL-I	- т	Reset; The falling edge initiates a complete reset of the module including		
			the 2-wire serial interface, equivalent to a power cycle.		
22		VCC2	+1.8V Power Supply – Not required		
23		GND	Module Ground	1	
			Reference Clock non-inverted input, AC coupled on the host board –	3	
24	PECL-I RefCLK+		RefCLK+ Not required		
			Reference Clock inverted input, AC coupled on the host board – Not		
25	PECL-I	RefCLK-	required	3	
26		GND	Module Ground	1	
27		GND	Module Ground	1	
28	CML-I	TD-	Transmitter inverted data input		
29	CML-I	TD+	Transmitter non-inverted data input		
30		GND	Module Ground	1	

#### Notes:

1) Module circuit ground is isolated from module chassis ground within the module.

2) Open collector; should be pulled up with  $4.7k\Omega - 10k\Omega$  on host board to a voltage between 3.15V and 3.6V.

3) A Reference Clock input is not required by the EX8592-3LCD03. If present, it will be ignored.

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## **General Specifications**

Parameter		Symbol	Min	Тур	Max	Units	Ref.
	Bit Rate		9.95		11.3	Gb/s	1
В	Bit Error Ratio				10 <sup>-12</sup>		2
Maximum	Maximum Supported Distances						
Fiber Type	850nm OFL Bandwidth						
62.5µm	160MHz-km	Langu			26	~	
	OM1 500MHz-km	Lmax			33	m	
	400MHz-km				66		
50µm	OM2 500MHz-km	Lmax			82	m	
	OM3 2000MHz-km				300		

Notes:

- 1) 10GBASE-SR/SW, 1200-Mx-SN-I
- 2) Tested with 10.3Gbps,  $2^{31} 1$  PRBS

### **Digital Diagnostic Functions**

As defined by the XFP MSA1, ETU-LINK XFP transceivers provide digital diagnostic functions via a 2-wire serial interface, which allows real-time access to the following operating parameters:

- Transceiver temperature
- Laser bias current
- Transmitted optical power
- Received optical power
- Transceiver supply voltage

It also provides a sophisticated system of alarm and warning flags, which may be used to alert end-users when particular operating parameters are outside of a factory-set normal range.

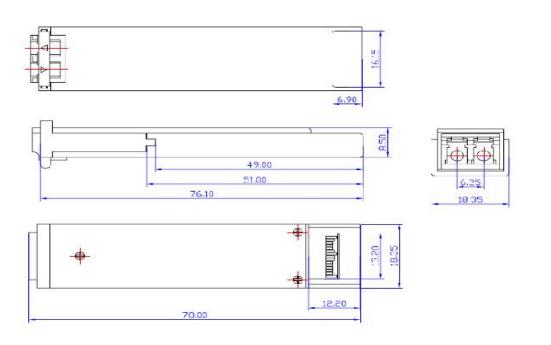
The operating and diagnostics information is monitored and reported by a Digital Diagnostics Transceiver Controller (DDTC) inside the transceiver, which is accessed through the 2-wire serial interface. When the serial protocol is activated, the serial clock signal (SCL pin) is generated by the host. The positive edge clocks data into the XFP transceiver into those segments of its memory map that are not write-protected.

The negative edge clocks data from the XFP transceiver. The serial data signal (SDA pin) is bi-directional for serial data transfer. The host uses SDA in conjunction with SCL to mark the start and end of serial protocol activation. The memories are organized as a series of 8-bit data words that can be addressed individually or sequentially. The 2-wire serial interface provides sequential or random access to the 8 bit parameters, addressed from 000h to the maximum address of the memory.

For more detailed information including memory map definitions, please see ETU-LINK's Application Note AN-2035 "Digital Diagnostic Monitoring Interface for XFP Optical Transceivers", or the XFP MSA Specification1.

## **Mechanical Specifications**

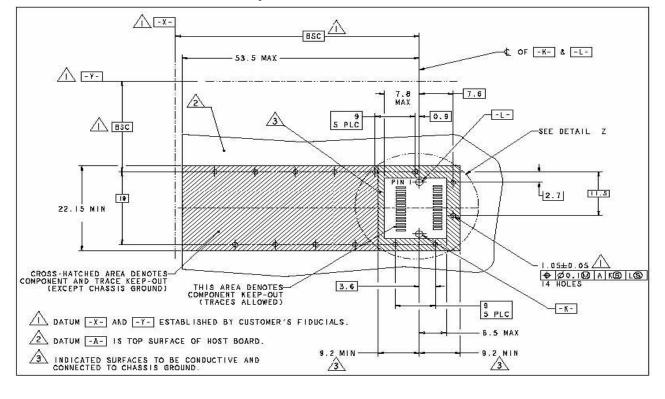
ETU-LINK's XFP transceivers are compliant with the dimensions defined by the XFP Multi-Sourcing Agreement (MSA).

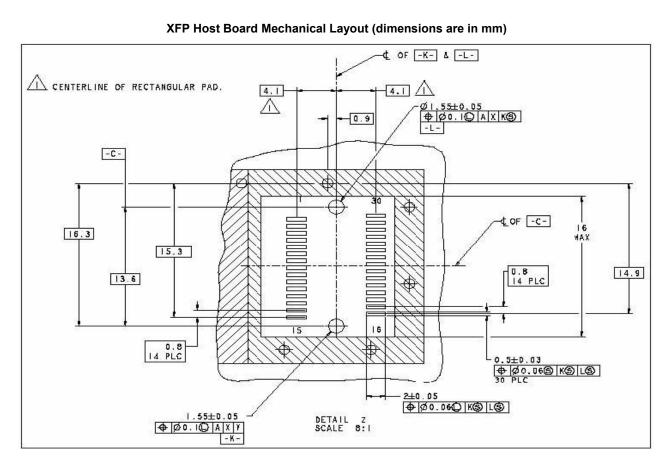


XFP Transceiver (dimensions are in mm)

## **PCB Layout and Bezel Recommendations**

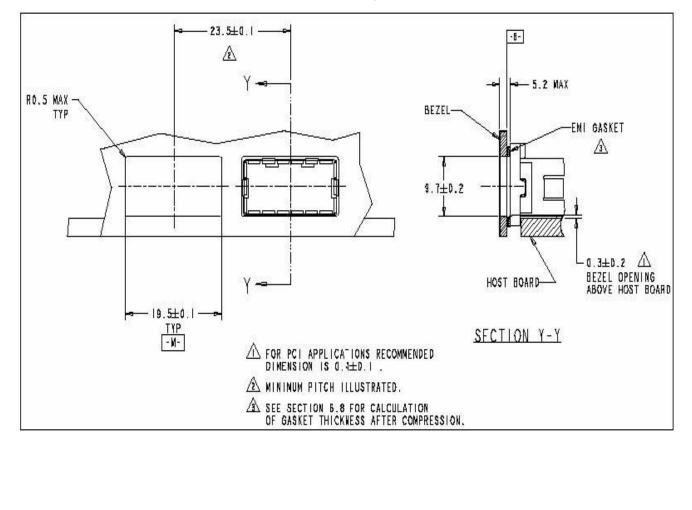
PCB Layout and Bezel Recommendations





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XFP Detail Host Board Mechanical Layout (dimensions are in mm)



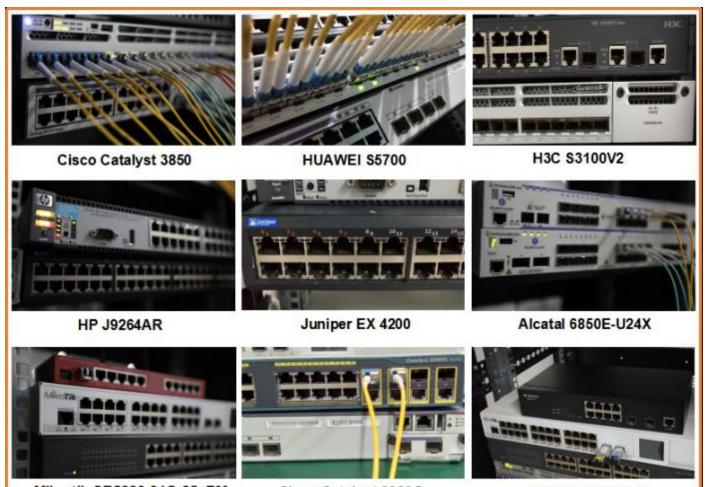
### **Regulatory Compliance**

Feature	Reference	Performance	
Electrostatic discharge (ESD)	IEC/EN 61000-4-2	Compatible with standards	
Electromagnetic Interference (EMI)	FCC Part 15 Class B EN 55022 Class B	Compatible with standards	
	(CISPR 22A)		
Lapor Evo Sofoty	FDA 21CFR 1040.10, 1040.11 IEC/EN		
Laser Eye Safety	60825-1, 2	Class 1 laser product	
Component Recognition	IEC/EN 60950, UL	Compatible with standards	
ROHS	2002/95/EC	Compatible with standards	
EMC	EN61000-3	Compatible with standards	

### **Compatibility Test**

In order to ensure the product compatibility, our products will be tested on the switch before shipment. Our modules can compatible with many mainstream brand switches, such as Cisco, Juniper, Extreme, Brocade, IBM, H3C, HP, Huawei, D-Link, Mikrotik, ZTE, TP-Link...

Our test equipment: VOLKTEK MEN-4110, HP 2530-8G, CRS226-24G-25+RM, Catalyst 2960G Series, Catalyst 3850 XS 10G SFP+, Catalyst 3750-E Series, HUAWEI S5700Series, H3C S3100V2 Series, Juniper-EX4200, etc.



#### Mikrotik CR5226-24G-25+RM

#### Cisco Catalyst 2960G

#### Volktek MEN-4110

## **Product Production Process**

# **Quality Assurance**

Continuous introduction of new equipment, produced by strict standards, strict quality inspection, to guarantee the high quality standard of each product.



